

Discovery kits with STM32MP157 MPUs

Introduction

The **STM32MP157A-DK1** and **STM32MP157C-DK2** Discovery kits are designed as complete demonstration and development platforms for STMicroelectronics Arm®-based dual Cortex®-A7 32 bits and Cortex®-M4 32 bits MPUs in the **STM32MP1 Series** and their **STPMIC1** companion chip. They leverage the capabilities of STM32MP1 Series microprocessors to allow users develop applications using STM32 MPU OpenSTLinux Distribution software (such as **STM32MP1Starter**) for the main processor and **STM32CubeMP1** software for the co-processor.

They feature 16-bit DDR3L 4 Gbits at 533 MHz, MIPI DSISM 2 lanes at 1 Gbps, USB Type-C™ DRP HS port, USB Type-A Host HS ports, audio codec with analog audio input / output, microSD™ card high-speed mode up to 50 MHz, Gigabit Ethernet, HDMI® up to 720p60 (1280 × 720), 40-pin extended GPIOs, Arduino™, Wi-Fi® 802.11b/g/n, Bluetooth® Low Energy 4.1, and ST-LINK/V2.1 (UART console).

The STM32MP157C-DK2, shown with display removed in [Figure 1](#) and [Figure 2](#), is used as a reference design for user application development. It cannot be considered as the hardware design of a final application.

The hardware features of the Discovery kits are available for users to develop their applications: USB, Ethernet, LTDC, TFT LCD MIPI DSISM, microSD™ card, audio codec, user buttons, Wi-Fi®, and Bluetooth® Low Energy. Extension headers allow easy connection of an Arduino™ board for a specific application.

An ST-LINK/V2-1 is integrated on the board, as embedded in-circuit debugger and programmer for the STM32 MPU and the USB Virtual COM port bridge.

Figure 1. STM32MP157C-DK2 top view

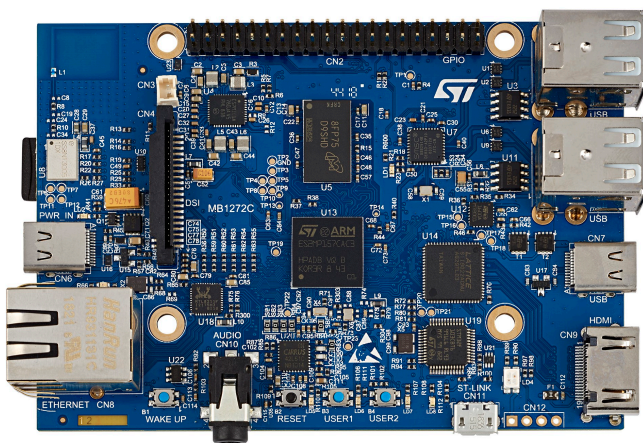
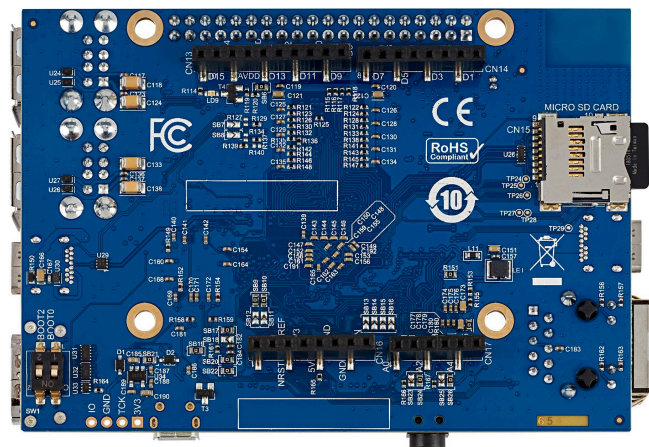


Figure 2. STM32MP157C-DK2 bottom view



Pictures are not contractual.

1 Features

- Common features
 - STM32MP157 Arm[®]-based dual Cortex[®]-A7 32 bits + Cortex[®]-M4 32 bits MPU in TFBGA361 package
 - ST PMIC [STPMIC1](#)
 - 4-Gbit DDR3L, 16 bits, 533 MHz
 - 1-Gbps Ethernet (RGMII) compliant with IEEE-802.3ab
 - USB OTG HS
 - Audio codec
 - 4 user LEDs
 - 2 user and reset push-buttons, 1 wake-up button
 - 5 V / 3 A USB Type-C[™] power supply input (not provided)
 - Board connectors:
 - Ethernet RJ45
 - 4 × USB Host Type-A
 - USB Type-C[™] DRP
 - MIPI DSISM
 - HDMI[®]
 - Stereo headset jack including analog microphone input
 - microSD[™] card
 - GPIO expansion connector (Raspberry Pi[®] shields capability)
 - Arduino[™] Uno V3 expansion connectors
 - On-board ST-LINK/V2-1 debugger/programmer with USB re-enumeration capability: Virtual COM port and debug port
 - [STM32CubeMP1](#) and full mainline open-source Linux[®] STM32 MPU OpenSTLinux Distribution (such as [STM32MP1Starter](#)) software and examples
 - Support of a wide choice of Integrated Development Environments (IDEs) including IAR[™], Keil[®], GCC-based IDEs
- Board-specific features
 - 4" TFT 480×800 pixels with LED backlight, MIPI DSISM interface, and capacitive touch panel
 - Wi-Fi[®] 802.11b/g/n
 - Bluetooth[®] Low Energy 4.1

Note: Arm is a registered trademark of Arm Limited (or its subsidiaries) in the US and/or elsewhere.



2 Ordering information

To order an STM32MP157 Discovery kit, refer to [Table 1](#). Additional information is available from the datasheet and reference manual of the target STM32.

Table 1. List of available products

| Order code | Board reference | Target STM32 | Differentiating feature |
|-----------------|-------------------------------------|----------------|--|
| STM32MP157A-DK1 | • MB1272 | STM32MP157AAC3 | • Basic security |
| STM32MP157C-DK2 | • MB1272 • MB1407 ⁽¹⁾ | STM32MP157CAC3 | • Secure Boot and cryptography • LCD • Wi-Fi® • Bluetooth® Low Energy |

1. LCD extension board.

2.1 Product marking

Evaluation tools marked as “ES” or “E” are not yet qualified and therefore not ready to be used as reference design or in production. Any consequences deriving from such usage will not be at ST charge. In no event, ST will be liable for any customer usage of these engineering sample tools as reference design or in production.

“E” or “ES” marking examples of location:

- On the targeted STM32 that is soldered on the board (for illustration of STM32 marking, refer to the STM32 datasheet “Package information” paragraph at the www.st.com website).
- Next to the evaluation tool ordering part number that is stuck or silk-screen printed on the board.

2.2 Codification

The meaning of the codification is explained in [Table 2](#).

Table 2. Codification explanation

| STM32MP1XXY-DKZ | Description | Example: STM32MP157C-DK2 |
|-----------------|--|--|
| STM32MP1 | MPU series in STM32 Arm Cortex MPUs | STM32MP1 Series |
| XX | MPU product line in the series | STM32MP157 line |
| Y | Security option: <ul style="list-style-type: none"> • A: basic security • C: Secure Boot and cryptography | Secure Boot and cryptography |
| DKZ | Discovery kit configuration: <ul style="list-style-type: none"> • DK1: basic • DK2: LCD, Wi-Fi®, and Bluetooth® Low Energy | LCD, Wi-Fi®, and Bluetooth® Low Energy |

The order code is mentioned on a sticker placed on the top side of the board.

3 Development environment

3.1 Demonstration software

The STM32 MPU OpenSTLinux Distribution and STM32CubeMP1 base demonstration software is preloaded in the microSD™ for easy demonstration of the device peripherals in standalone mode. The latest versions of the demonstration source code and associated documentation can be downloaded from www.st.com.

3.2 Development toolchains

- Keil® MDK-ARM (see [note](#))
- IAR™ EWARM (see [note](#))
- GCC-based IDEs
- GCC

Note: On Windows® only.

3.3 System requirements

- Windows® OS (7, 8 and 10), Linux® 64-bit, or macOS®
- USB Type-C™ to USB Type-C™ charger 5 V / 3 A
- USB Type-C™ to Type-A cable
- USB Type-A to Micro-B cable

Note: macOS® is a trademark of Apple Inc. registered in the U.S. and other countries.

4 Technology partners

MICRON

- 4-Gbit DDR3L, 16 bits, part number MT41K256M16TW-107-P-V00H

MURATA

- Wi-Fi® 802.11b/g/n + Bluetooth® Low Energy 4.1, part number LBEE5KL1DX-883

5 Conventions

Table 3 provides the conventions used for the ON and OFF settings in the present document.

Table 3. ON/OFF convention

| Convention | Definition |
|-----------------------|---|
| Jumper JPx ON | Jumper fitted |
| Jumper JPx OFF | Jumper not fitted |
| Jumper JPx [1-2] | Jumper should be fitted between Pin 1 and Pin 2 |
| Solder bridge SBx ON | SBx connections closed by 0 Ω resistor |
| Solder bridge SBx OFF | SBx connections left open |
| Resistor Rx ON | Resistor soldered |
| Resistor Rx OFF | Resistor not soldered |

6 Delivery recommendations

Before the first use, make sure that no damage occurred to the board during shipment and no socketed components are not firmly fixed in their sockets or loose in the plastic bag.

7 Hardware layout and configuration

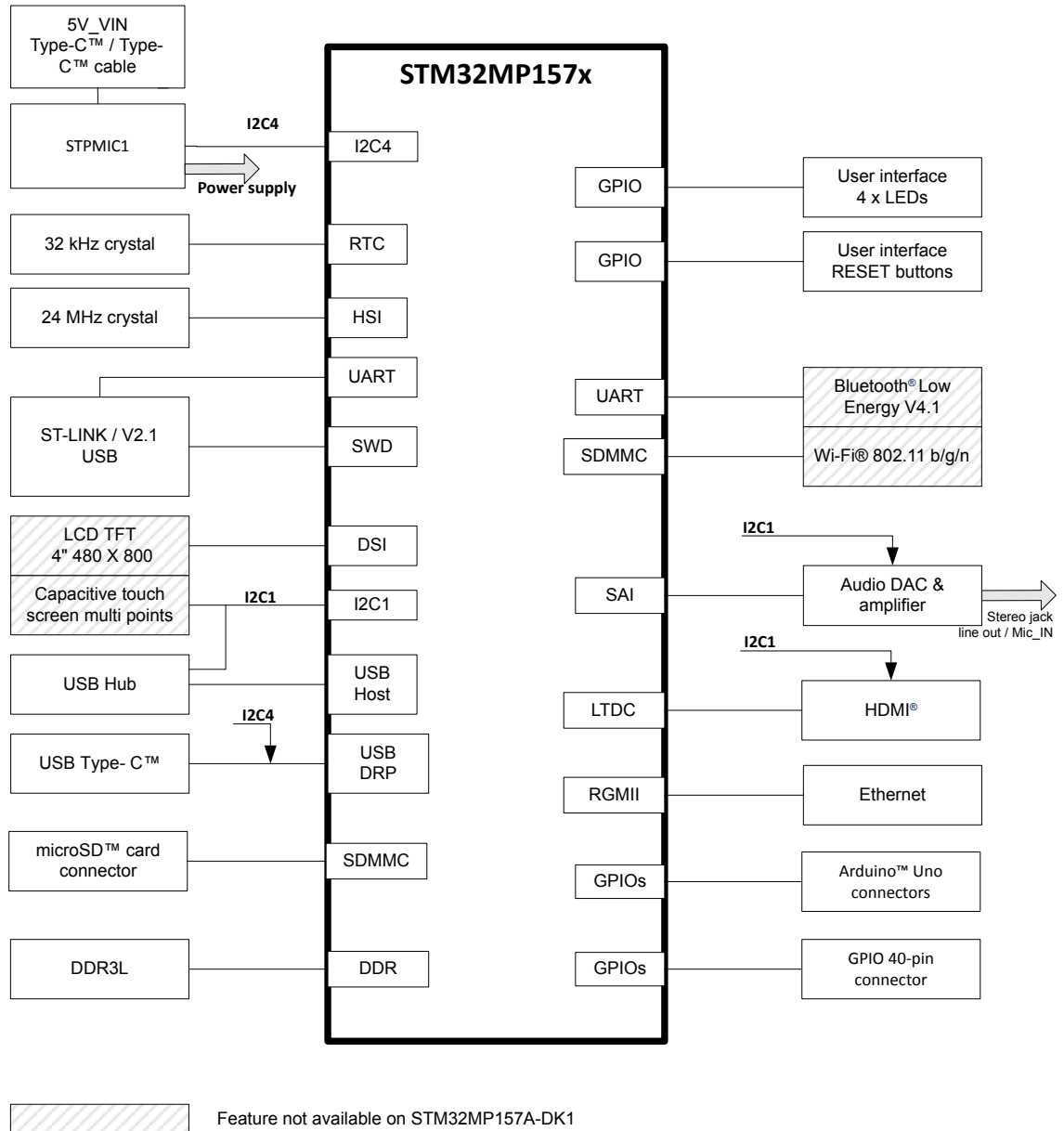
Figure 3. STM32MP157x-DKx hardware block diagram


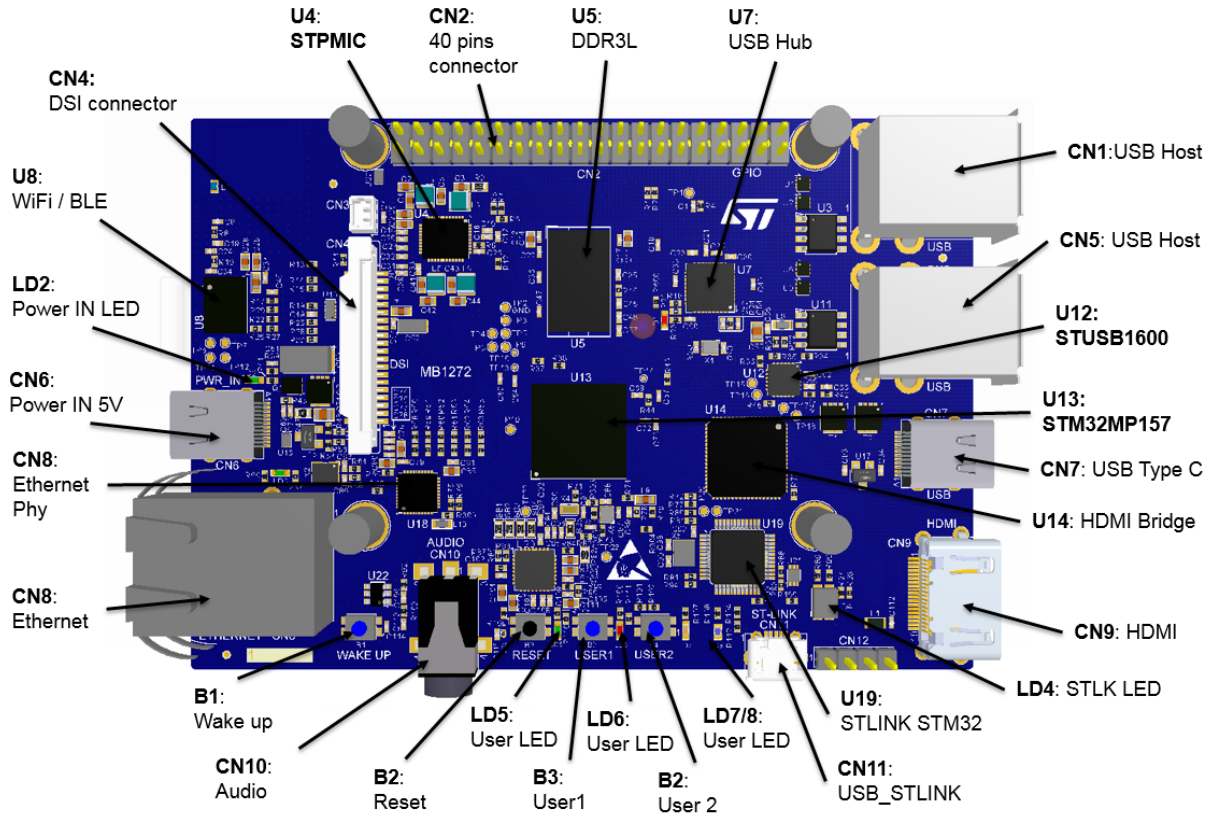
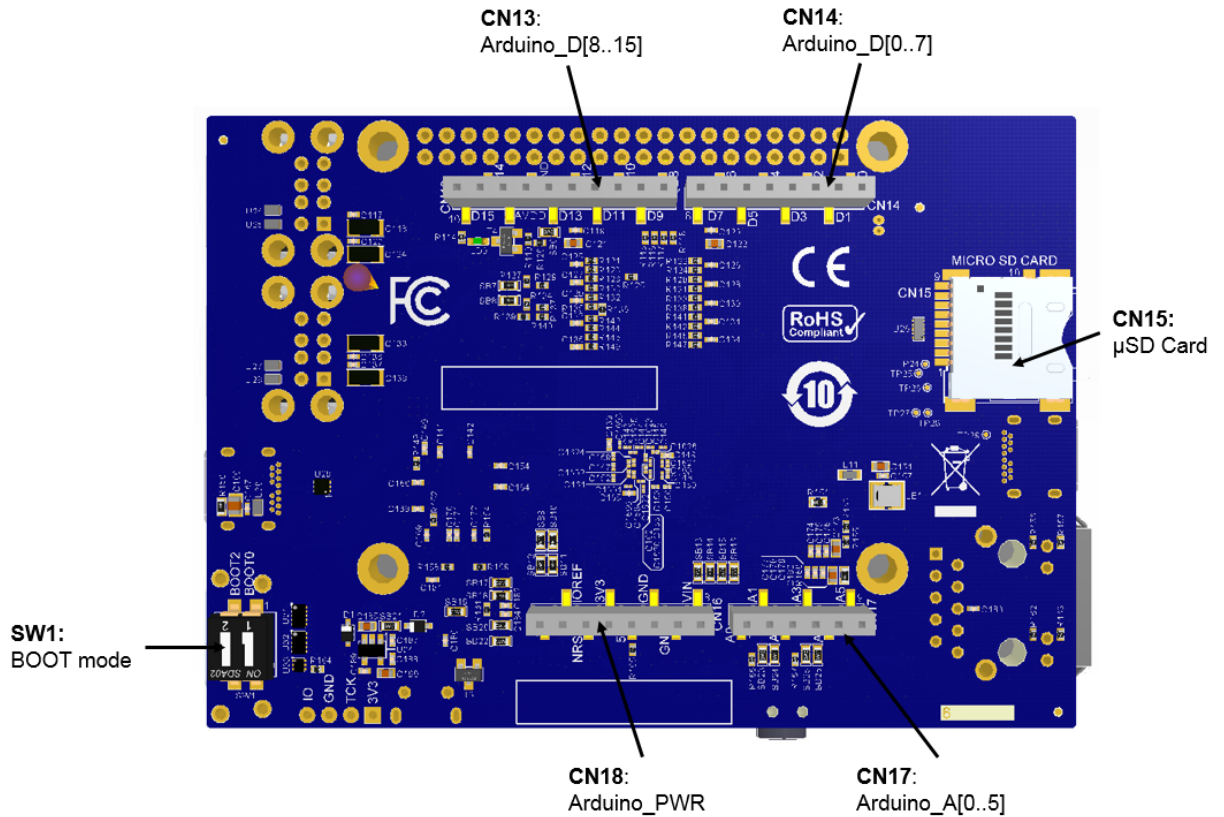
Figure 4. STM32MP157X-DKX PCB layout: TOP side


Figure 5. STM32MP157X-DKX PCB layout: BOTTOM side



7.1 Embedded ST-LINK/V2-1

7.1.1 Description

To debug the onboard STM32 MPU, the ST-LINK/V2.1 programming and debugging tool is integrated in the STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits. The embedded ST-LINK/V2.1 supports only SWD and VCP for STM32 devices. For information about the debugging and programming features of ST-LINK/V2.1, refer to the *ST-LINK/V2 in-circuit debugger/programmer for STM8 and STM32 user manual (UM1075)*. It is recommended to power supply the board (5V_VIN) before plugging the USB debug cable to the Micro-B connector.

Figure 6. CN11 ST-LINK USB Micro-B connector pinout

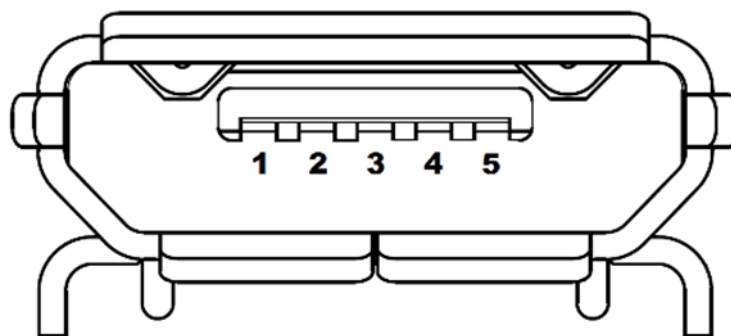


Table 4. CN11 ST-LINK USB Micro-B connector pinout

| Pin | Pin name | Signal name | ST-LINK STM32 pin | Function |
|-----|----------|----------------|-------------------|------------|
| 1 | VBUS | 5V_USB_ST_LINK | - | VBUS Power |
| 2 | DM | USB_STLK_N | PA11 | DM |
| 3 | DP | USB_STLK_P | PA12 | DP |
| 4 | ID | - | GND | ID |
| 5 | GND | GND | GND | GND |

7.1.2 Drivers

Before connecting STM32MP157A-DK1 or STM32MP157C-DK2 to a Windows® (7, 8, or 10) PC via USB, a driver for ST-LINK/V2.1 must be installed (not required for Windows® 10). It is available from the www.st.com website.

In case the STM32MP157A-DK1 or STM32MP157C-DK2 Discovery kit is connected to the PC before the driver is installed, some Discovery kit interfaces may be declared as “Unknown” in the PC device manager. In this case, the user must install the dedicated driver files, and update the driver of the connected device from the device manager.

7.1.3 ST-LINK/V2-1 firmware upgrade

The ST-LINK/V2-1 embeds a firmware upgrade mechanism for in-situ upgrade through the USB port. As firmware may evolve during the lifetime of the ST-LINK/V2-1 product (addition of new functionalities, bug fixes, or support of new microprocessor families), it is recommended to visit periodically the www.st.com website before starting to use the STM32MP157A-DK1 or STM32MP157C-DK2 Discovery kit to stay up-to-date with the latest firmware version.

7.2 Power supply

7.2.1 5 V power supply

The STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits are designed to be powered by a 5 V DC power source at 3 A maximum such as:

- 5V_VBUS connected to the CN6 connector through a USB Type-C™ to USB Type-C™ cable
 - The two lines USB_PWR_CC1 and USB_PWR_CC2 are connected to PA4 and PA5 respectively to check what is connected to CN6 and control features enabling:
 - Legacy cable
 - Personal computer
 - 5 V DC power source at 3 A

Depending on the current needed on the devices connected to the USB port, and the board itself, power limitations can prevent the system from working as expected. The user must ensure that the STM32MP157A-DK1 or STM32MP157C-DK2 Discovery kit is supplied with the correct power source depending on the current needed. It is recommended to use a USB Type-C™ to USB Type-C™ 5 V/3 A charger.

7.2.2 STPMIC1 power supply

For general information concerning the **STPMIC1**, refer to the datasheet on the www.st.com website.

STPMIC1 supply

- VDD_CORE (BUCK1) used to supply the core of the STM32MP157x
 - Value: 1.2 V
- VDD_DDR (BUCK2) used to supply the DDR core and I/Os
 - Value: 1.35 V
- VDD (BUCK3) used to supply the VDDA and VDD domains of the STM32MP157x
 - Value: 3.3 V
- 3V3 (BUCK4) used to provide the 3.3 V to the different features available on the Discovery kit
 - Value: 3.3 V

- VREF_DDR used to supply the DDR reference voltage
 - Value: 1.65 V
- VTT_DDR (LDO3) used to supply the termination resistors of the DDR
 - Value: 1.65 V
- 1V8_Audio (LDO1) used to supply the digital/analog of the audio codec
 - Value: 1.8 V
- 1V2_HDMI (LDO6) used to supply the digital core and analog part of the HDMI transceiver
 - Value: 1.2 V
- 3V3_HDMI (LDO2) used to supply the I/Os of the HDMI transceiver
 - Value: 3.3 V
- VDD_USB (LDO4) used to supply the USB phy of the STM32MP157x
 - Value: 3.3 V

7.3 Clock sources

7.3.1 LSE clock references

The LSE clock references on the STM32MP157x microprocessor are provided by the external crystal X2:

- 32.768 kHz crystal from NDK : reference NX2012SA

7.3.2 HSE clock references

The HSE clock references on the STM32MP157x microprocessor are provided by the external crystal X6:

- 24 MHz crystal from NDK : reference NX2016SA

7.4 Reset sources

The reset signal of STM32MP157A-DK1 and STM32MP157C-DK2 is active low. The internal PU forces the RST signal to a high level.

The sources of reset are:

- Reset button B2 (black button)
- STPMIC1
- Embedded ST-LINK/V2.1
- Arduino™ connector CN16: pin 3, reset from the Arduino™ board
- STM32MP157x

7.5 Boot mode

7.5.1 Description

At startup, the boot source used by the internal bootROM is selected by the Boot pins. [Table 5](#) describes the configurations of the Boot pins.

Table 5. Boot mode pins

| Boot 0 | Boot 1 ⁽¹⁾ | Boot 2 | Boot mode |
|--------|-----------------------|--------|-------------------------------|
| 0 | 0 | 0 | Forced USB boot for flashing. |
| 1 | 0 | 0 | Not supported. |
| 0 | 0 | 1 | Reserved. |
| 1 | 0 | 1 | SD card on SDMMC1. |

1. Pin Boot 1 is always tied to "0" by a pull-down resistor.

Figure 7 shows the configurations of the boot-related switch SW1.

Figure 7. Boot-mode switch SW1



7.6 Audio

7.6.1 Description

The CS42L51-CNZ codec is connected through an SAI interface to the STM32MP157x microcontroller. This component supports the TDM feature of the SAI port. The TDM feature offers STM32MP157x the capability to stream stereo audio channels.

7.6.2 Operating voltage

The audio codec has two power supplies:

- VL, connected to the 3.3 V provided by the STPMIC1
- 1V8_AUDIO, dedicated 1.8 V source provided by the STPMIC1

7.6.3 Audio codec interface

Audio codec interfacing is performed through the SAI2 and I2C1 interfaces of the STM32MP157x.

Table 6 describes the I/O configuration of the audio codec interface.

Table 6. I/O configuration for the audio interface

| I/O | Configuration |
|------|---|
| PG9 | PG9 used as AUDIO RESETN (active LOW) |
| PE0 | PE0 used as SAI2_MCLKA |
| PF11 | PF11 used as SAI2_SDB shared with GPIO expansion |
| PI7 | PI7 used as SAI2_FSA shared with GPIO expansion |
| PI5 | PI5 used as SAI2_SCKA shared with GPIO expansion |
| PI6 | PI6 used as SAI2_SDA shared with GPIO expansion |
| PD12 | PD12 used as I2C1_SCL shared between USB, DSI, HDMI |
| PF15 | PB7 used as I2C1_SDA shared between USB, DSI, HDMI |

7.6.4 Headphone outputs

The STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits can drive a stereo headphone. The STM32MP157x sends the stereo audio channels to the codec via its SAI2 TDM port. The codec converts the digital audio stream to stereo analog signals. It then boosts them for direct drive of the headphone connected to the CN10 3.5 mm stereo jack receptacles on the board.

The audio codec is set by an I²C bus. The address is a 7 bit address plus one bit for read/write (high for read, low for write). The AD0 pin, connected to GND, gives the least-significant address bit. The address of the audio codec is 0b1001010x: 0x94 to write and 0x95 to read.

7.6.5 Audio jack connector

Figure 8 shows the CN10 audio jack connector pinout.

Figure 8. CN10 audio jack connector pinout

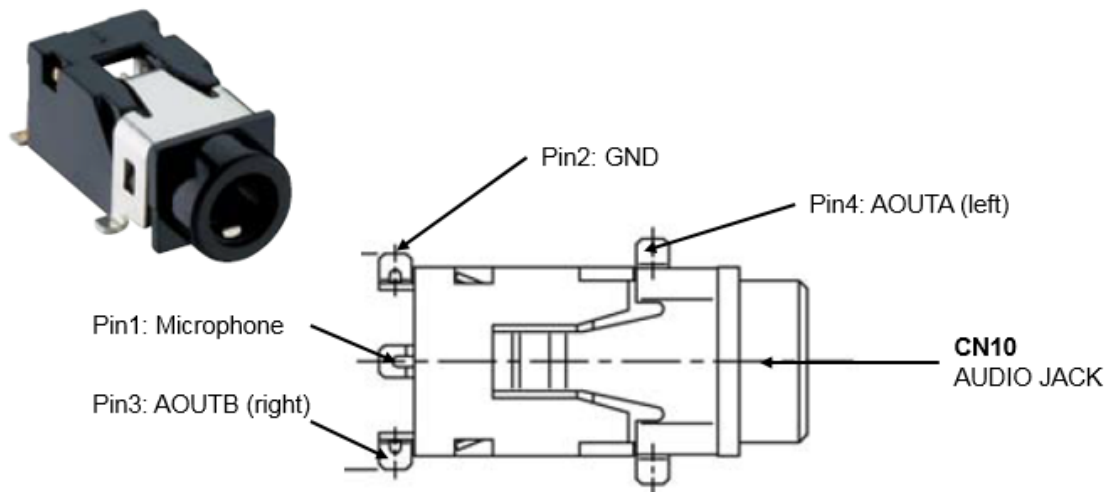


Table 7 describes the CN10 audio jack connector pinout.

Table 7. CN10 audio jack connector pinout

| Pin | Pin name | Signal name | Codec pin | Function |
|-----|----------|-------------|-----------|-------------------|
| 1 | 1 | MIC_IN | MICIN1 | Microphone IN |
| 2 | 2 | GND | GND | GND |
| 3 | 3 | AOUTB | AOUTB | OUT_SPEAKER_RIGHT |
| 4 | 4 | AOUTA | AOUTA | OUT_SPEAKER_LEFT |

7.6.6 I/O restriction

SAI2 is shared between the audio codec and the GPIO expansion connector. By default, the audio codec is available because of solder bridges SB13, SB14, SB15, and SB16.

7.7 USB Host

7.7.1 Description

The STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits provide four USB Host ports (dual-USB sockets CN1 and CN5) through the use of the USB2514B-AEZC USB Hub. The USB2514B-AEZC has a full power management for each USB port: no I/O is needed from the STM32MP157x.

7.7.2 USB Host interface

Table 8 describes the I/O configuration for the USB Host interface.

Table 8. I/O configuration for the USB Host interface

| I/O | Configuration |
|---------|--|
| PD12 | PD12 used as I2C1_SCL shared between AUDIO, DSI, and HDMI ⁽¹⁾ |
| PF15 | PF15 used as I2C1_SDA shared between AUDIO, DSI, and HDMI ⁽¹⁾ |
| USB_DP1 | USB1_P |
| USB_DM1 | USB1_N |

1. I2C1 not connected by default (SB7 and SB8 OFF).

Figure 9 shows the CN1 and CN5 USB Type-A connector pinout.

Figure 9. CN1 and CN5 USB Type-A connector pinout

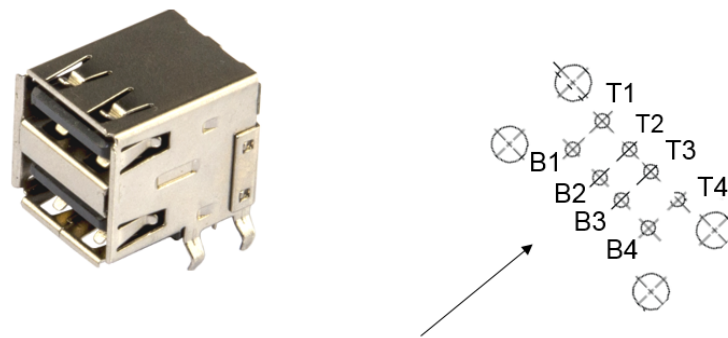


Table 9 describes CN1 and CN5 USB Host connector pinout.

Table 9. CN1 and CN5 USB Host connector pinout

| Pin | Pin name | Signal name | Function |
|------------|----------|-------------|----------|
| CN1 | | | |
| T1 | T1 | VBUS | VBUS |
| T2 | T2 | USB1CN25_N | DM |
| T3 | T3 | USB1CN25_P | DP |
| T4 | T4 | GND | GND |
| B1 | B1 | VBUS | VBUS |
| B2 | B2 | USB1CN25_N | DM |
| B3 | B3 | USB1CN25_P | DP |
| B4 | B4 | GND | GND |
| CN5 | | | |
| T1 | T1 | VBUS | VBUS |
| T2 | T2 | USB1CN26_N | DM |

| Pin | Pin name | Signal name | Function |
|-----|----------|-------------|----------|
| T3 | T3 | USB1CN26_P | DP |
| T4 | T4 | GND | GND |
| B1 | B1 | VBUS | VBUS |
| B2 | B2 | USB1CN26_N | DM |
| B3 | B3 | USB1CN26_P | DP |
| B4 | B4 | GND | GND |

7.8 USB Type-C™ HS

7.8.1 Description

The STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits support USB high-speed (HS) communication. USB connector CN7 is a USB Type-C™ connector.

The STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits support USB Type-C™ Source mode.

7.8.2 Operating voltage

The STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits support 5 V USB voltage from 4.75 V to 5.25 V.

7.8.3 USB HS Source

When a *USB Device* connection to the CN7 USB Type-C™ connector of STM32MP157A-DK1 or STM32MP157C-DK2 is detected, the Discovery kit starts behaving as a *USB Host*.

7.8.4 USB Type-C™ connector

Figure 10 shows the pinout of USB Type-C™ connector CN7.

Figure 10. CN7 USB Type-C™ connector pinout

| | | | | | | | | | | | |
|-----|------|------|------|------|----|----|------|------|------|------|-----|
| A1 | A2 | A3 | A4 | A5 | A6 | A7 | A8 | A9 | A10 | A11 | A12 |
| GND | TX1+ | TX1- | VBUS | CC1 | D+ | D- | SBU1 | VBUS | RX2- | RX2+ | GND |
| GND | RX1+ | RX1- | VBUS | SBU2 | D- | D+ | CC2 | VBUS | TX2- | TX2+ | GND |
| B12 | B11 | B10 | B9 | B8 | B7 | B6 | B5 | B4 | B3 | B2 | B1 |

Table 10 describes the pinout of USB Type-C™ connector CN7.

Table 10. CN7 USB Type-C™ connector pinout

| Function | STM32 pin | Signal name | Pin name | Pin | Pin | Pin name | Signal name | STM32 pin | Function |
|----------|-----------|-------------|----------|-----|-----|----------|-------------|-----------|----------|
| GND | - | GND | GND | A1 | B12 | GND | GND | - | GND |
| TX1+ | - | - | TX1+ | A2 | B11 | RX1+ | - | - | RX1+ |
| TX1- | - | - | TX1- | A3 | B10 | RX1- | - | - | RX1- |
| VBUS | - | - | VBUS | A4 | B9 | VBUS | - | - | VBUS |
| CC1 | - | - | CC1 | A5 | B8 | SBU2 | - | - | SBU2 |

| Function | STM32 pin | Signal name | Pin name | Pin | Pin | Pin name | Signal name | STM32 pin | Function |
|----------|-----------|-------------|----------|-----|-----|----------|-------------|-----------|----------|
| D+ | USB_DP2 | USB_DP2 | D+ | A6 | B7 | D- | USB_DM2 | USB_DM2 | D- |
| D- | USB_DM2 | USB_DM2 | D- | A7 | B6 | D+ | USB_DP2 | USB_DP2 | D+ |
| SBU1 | - | - | SBU1 | A8 | B5 | CC2 | - | - | CC2 |
| VBUS | - | - | VBUS | A9 | B4 | VBUS | - | - | VBUS |
| RX2- | - | - | RX2- | A10 | B3 | TX2- | - | - | TX2- |
| RX2+ | - | - | RX2+ | A11 | B2 | TX2+ | - | - | TX2+ |
| GND | - | GND | GND | A12 | B1 | GND | GND | - | GND |

7.9 microSD™ card

7.9.1 Description

The CN15 slot for the microSD™ card is routed to STM32MP157x SDIO port (SDMMC1). This interface is compliant with *SD Memory Card Specification Version 3.01: SDR50*.

7.9.2 Operating voltage

The microSD™ card interface is only compatible with the 3.3 V voltage range: from 2.7 V to 3.6 V. All microSD™ card types are supported (including SDHC and SDXC), but only Default and High-Speed modes (3 V) are supported on STM32MP157A-DK1 and STM32MP157C-DK2. UHS-I modes (1.8 V) are not supported on these Discovery kits.

7.9.3 microSD™ card interface

The microSD™ card interface is used in the four data lines D[0:3] with one clock (CLK), one command line (CMD), and one card detection signal (CARD_DETECT).

The SDMMC1 is a bootable interface.

Table 11 describes the I/O configuration for the SDIO interface.

Table 11. I/O configuration for the SDIO interface

| I/O | Configuration |
|------|-------------------------------------|
| PB7 | PB7 is connected to μ SD_DETECT |
| PC8 | PC8 is connected to SDMMC1_D0 |
| PC9 | PC9 is connected to SDMMC1_D1 |
| PC10 | PC10 is connected to SDMMC1_D2 |
| PC11 | PC11 is connected to SDMMC1_D3 |
| PC12 | PC12 is connected to SDMMC1_CLK |
| PD2 | PD2 is connected to SDMMC1_CMD |

Figure 11 shows the pinout of the microSD™ connector CN15.

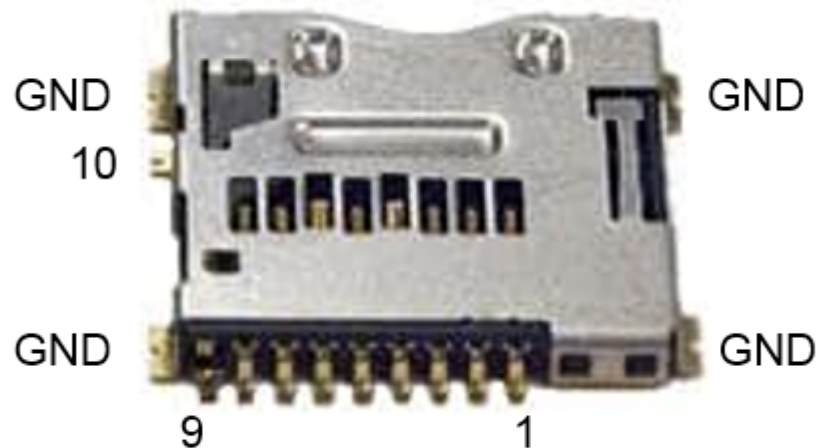
Figure 11. microSD™ card connector CN15


Table 12 describes pinout of the microSD™ connector CN15.

Table 12. CN15 microSD™ connector pinout

| Pin | Pin name | Signal name | STM32 pin | Function |
|-----|-------------|-------------|-----------|--------------------------|
| 1 | DAT2 | SDMMC1_D2 | PC10 | SDIO.D2 |
| 2 | DAT3_CD | SDMMC1_D3 | PC11 | SDIO.D3 |
| 3 | CMD | SDMMC1_CMD | PD2 | SDIO.CMD |
| 4 | 3V3 | 3V3 | - | VDD_SDCARD |
| 5 | CLK | SDMMC1_CLK | PC12 | SDIO.CLK |
| 6 | VSS | GND | - | GND |
| 7 | DAT0 | SDMMC1_D0 | PC8 | SDIO.D0 |
| 8 | DAT1 | SDMMC1_D1 | PC9 | SDIO.D1 |
| 9 | GND | GND | - | GND |
| 10 | CARD_DETECT | uSD_DETECT | PB7 | SDCARD_DETECT active LOW |

7.10 LEDs

7.10.1 Description

The LD2 LED turns green when the power cable is inserted in connector CN6.

Two general-purpose color LEDs (LD7 and LD8) are available as light indicators:

- The LD7 orange LED is used as STM32Cube examples verdict LED.
- The LD8 blue LED is used as Linux® Heartbeat LED, which is blinking as long as Linux® is alive on the Cortex®-A.

The two user LEDs, the green LD5 and orange LD6 LEDs, are directly connected to the STM32MP157x.

7.10.2 Operating voltage

All LEDs are driven by the I/O level; they are operating in the 3.3 V voltage range.

7.10.3 LED interface

Table 13 describes the I/O configuration of the LED interface.

Table 13. I/O configuration of the LED interfaces

| I/O | Configuration |
|------|--|
| PA14 | PA14 is connected to the green LED LD4. Active Low. |
| PA13 | PA13 is connected to the red LED LD6. Active Low. |
| PH7 | PH7 is connected to the orange LED LD7. Active High. |
| PD11 | PD11 is connected to the blue LED LD8. Active High. |

7.11 Buttons

7.11.1 Description

The STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits provide four types of buttons:

- Wake-up button (B1)
 - Allows the platform to be woken up from any low-power mode
 - Connected to STPMIC1 PONKEY, which generates a wake up signal on STM32MP157x PA0
- Reset button (B2)
 - Used to reset the Discovery kit
- USER1 button (B3)
 - Used at boot time by U-Boot to enter the USB programming mode
- USER2 button (B4)
 - Used at boot time by U-Boot to enter the Android® Fastboot mode

7.11.2 I/O interface

Table 14 describes the I/O configuration for the physical user interface.

Table 14. I/O configuration for the physical user interface

| I/O | Configuration |
|------|--|
| NRST | Reset button (B2). Active Low. |
| - | Wake-up button (B1). Connected to the PONKEYn pin of the STPMIC1 |
| PA13 | USER2 user button (B4) |
| PA14 | USER1 user button (B3) |

7.12 HDMI®

7.12.1 Description

The STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits offer an HDMI® connection for a TV monitor through the use of the Lattice Semiconductor SiI9022A HDMI® transmitter.

The resolution is up to 720p60 (1280 × 720).

Input signals are 24 bits digital RGB (LTDC) for the video and I2S2 for the audio. Refer to the STM32MP157x datasheet for details.

The control signals are I2C1, one interruption, and a dedicated reset.

The Consumer Electronic Control (CEC) is also available through the HDMI® transmitter (transmitter bypassed).

7.12.2

HDMI® I/O interface

Table 15 describes the I/O configuration for the HDMI® interface.

Table 15. I/O configuration for the HDMI® interface

| I/O | Configuration |
|------|----------------------------------|
| PB6 | PB6 is connected to HDMI_CEC. |
| PD9 | PD9 is connected to LTDC_B0. |
| PG12 | PG12 is connected to LTDC_B1. |
| PG10 | PG10 is connected to LTDC_B2. |
| PD10 | PD10 is connected to LTDC_B3. |
| PI4 | PI4 is connected to LTDC_B4. |
| PA3 | PA3 is connected to LTDC_B5. |
| PB8 | PB8 is connected to LTDC_B6. |
| PD8 | PD8 is connected to LTDC_B7. |
| PE5 | PE5 is connected to LTDC_G0. |
| PE6 | PE6 is connected to LTDC_G1. |
| PH13 | PH13 is connected to LTDC_G2. |
| PH14 | PH14 is connected to LTDC_G3. |
| PH15 | PH15 is connected to LTDC_G4. |
| PI0 | PI0 is connected to LTDC_G5. |
| PI1 | PI1 is connected to LTDC_G6. |
| PI2 | PI2 is connected to LTDC_G7. |
| PH2 | PH2 is connected to LTDC_R0. |
| PH3 | PH3 is connected to LTDC_R1. |
| PH8 | PH8 is connected to LTDC_R2. |
| PH9 | PH9 is connected to LTDC_R3. |
| PH10 | PH10 is connected to LTDC_R4. |
| PC0 | PC0 is connected to LTDC_R5. |
| PH12 | PH12 is connected to LTDC_R6. |
| PE15 | PE15 is connected to LTDC_R7. |
| PG7 | PG7 is connected to LTDC_CLK. |
| PF10 | PF10 is connected to LTDC_DE. |
| PI10 | PI10 is connected to LTDC_HSYNC. |
| PI9 | PI9 is connected to LTDC_VSYNC. |
| PA9 | PA9 is connected to I2S2_CK. |
| PB9 | PB9 is connected to I2S2_WS. |
| PI3 | PI3 is connected to I2S2_SDO. |

| I/O | Configuration |
|------|---|
| PG1 | PG1 is connected to HDMI_INT. |
| PD12 | PD12 is connected to I2C1_SCL (I2C shared). |
| PF15 | PF15 is connected to I2C1_SDA (I2C shared). |
| PA10 | PA10 is connected to HDMI_N_RST |

Figure 12 shows the pinout of HDMI® connector CN9.

Figure 12. CN9 HDMI® connector pinout

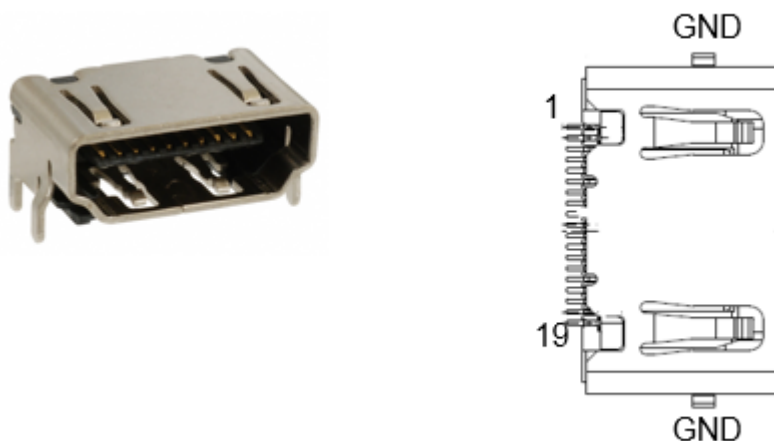


Table 16 describes the pinout of HDMI® connector CN9.

Table 16. CN9 HDMI® connector pinout

| Pin | Pin name | Signal name |
|-----|----------|-------------|
| 1 | RX2+ | TX2C_P |
| 2 | GND | GND |
| 3 | RX2- | TX2C_N |
| 4 | TX1+ | TX1C_P |
| 5 | GND | GND |
| 6 | RX1- | TX1C_N |
| 7 | RX0+ | TX0C_P |
| 8 | GND | GND |
| 9 | RX0- | TX0C_N |
| 10 | RXC+ | TXCC_P |
| 11 | GND | GND |
| 12 | RXC- | TXCC_N |
| 13 | CEC | CEC_A |
| 14 | - | - |

| Pin | Pin name | Signal name |
|-----|----------|-------------|
| 15 | SCL | DSCL |
| 16 | SDA | DSDA |
| 17 | GND | GND |
| 18 | +5V | 5V_VIN |
| 19 | DET | HPD |

7.13 Wi-Fi® and Bluetooth® Low Energy

7.13.1 Description

The STM32MP157C-DK2 Discovery kit support Wi-Fi® 802.11b/g/n and Bluetooth® Low Energy (BLE) V4.1. These functions are supported with the LBEE5KL1DX-883 MURATA module. This module is driven by a SDIO for the Wi-Fi® interface, and a USART for the Bluetooth®. The PCM format is used for audio data.

7.13.2 Operating voltage

The LBEE5KL1DX-883 module supports the 3.3 V voltage range.

7.13.3 Wi-Fi® I/O interface

Table 17 describes the I/O configuration for the Wi-Fi® interface.

Table 17. I/O configuration for the Wi-Fi® interface

| I/O | Configuration |
|------|----------------------------------|
| PB4 | PB4 is connected to SDMMC2_D3 |
| PB3 | PB3 is connected to SDMMC2_D2 |
| PB15 | PB15 is connected to SDMMC2_D1 |
| PB14 | PB14 is connected to SDMMC2_D0 |
| PG6 | PG6 is connected to SDMMC2_CMD |
| PE3 | PE3 is connected to SDMMC2_CK |
| PH4 | PH4 is connected to WL_REG_ON |
| PD0 | PD0 is connected to WL_HOST_WAKE |

7.13.4 Bluetooth® Low Energy I/O interface

Table 18 describes the I/O configuration for the Bluetooth® Low Energy interface.

Table 18. I/O configuration for the Bluetooth® Low Energy interface

| I/O | Configuration |
|-----|--------------------------------|
| PD5 | PD5 is connected to USART2_TX |
| PD6 | PD6 is connected to USART2_RX |
| PD4 | PD4 is connected to USART2_RTS |
| PD3 | PD3 is connected to USART2_CTS |

| I/O | Configuration |
|-----|----------------------------------|
| PZ3 | PZ3 is connected to BT_PCM_WS |
| PZ2 | PZ2 is connected to BT_PCM_SDO |
| PZ1 | PZ1 is connected to BT_PCM_SDI |
| PZ0 | PZ0 is connected to BT_PCM_CK |
| PZ6 | PZ6 is connected to BT_REG_ON |
| PH5 | PH5 is connected to BT_HOST_WAKE |
| PZ7 | PZ7 is connected to BT_DEV_WAKE |
| PI8 | LP0_32 |

7.14 MIPI DSISM LCD

The LCD is not provided with the STM32MP157A-DK1 Discovery kit.

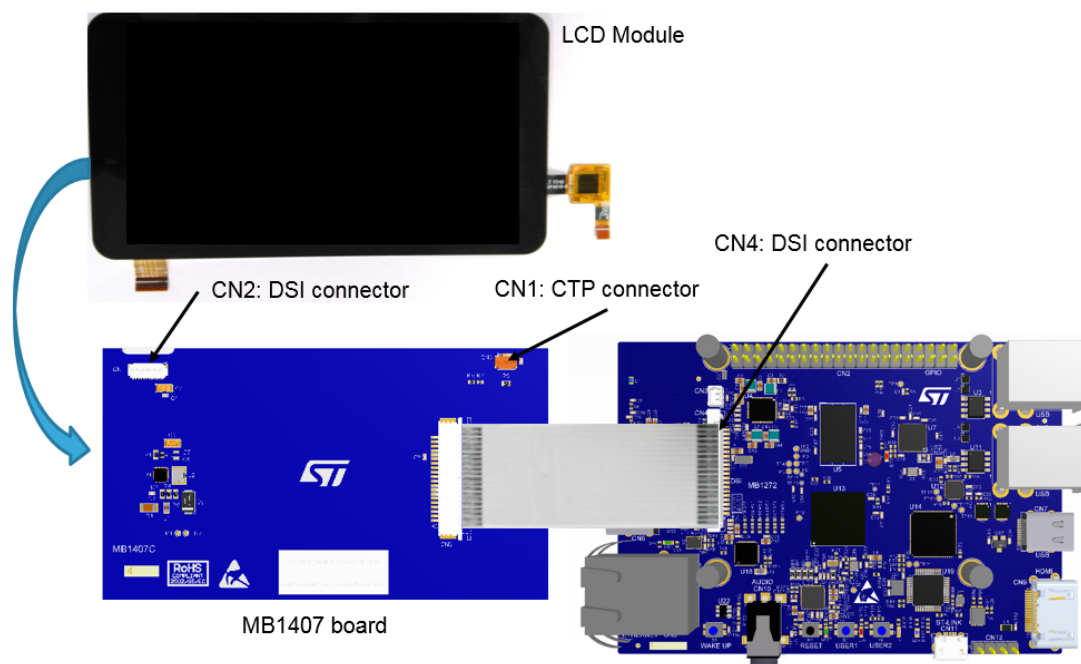
7.14.1 Description

The 40-pin FCP connector CN4 is used to connect a TFT LCD module through the MIPI DSISM interface supported by the MB1407 board. The touch panel is embedded in the LCD module.

The LCD module is composed of the FRD397B2509V2 TFT LCD module with an OTM8009A LCD driver. The 4" LCD supports a resolution of 480 × 800 dots in 16.7 M colors (RGB). The touch-sensitive panel drive is performed by the FT6236 self-capacitive controller.

Figure 13 shows the LCD connection to MB1407 and MB1272.

Figure 13. LCD connection to MB1407



7.14.2 Operating voltage

The LCD module power supply is connected to VDD_3V3.

The touch panel power supply is connected to VDD_3V3.

The backlight of the LCD is driven by the STLD40DPUR circuit on the MB1407 board connected to VDD_3V3.

7.14.3 LCD interface

Table 19 describes the I/O configuration of the LCD and CTP interfaces.

Table 19. I/O configuration of the LCD and CTP interfaces

| I/O | Configuration |
|---------|---|
| DSI_D0P | DSI_D0P is used as MIPI-DSI data Lane 0 positive. |
| DSI_D0N | DSI_D0N is used as MIPI-DSI data Lane 0 negative. |
| DSI_D1P | DSI_D1P is used as MIPI-DSI data Lane 1 positive. |
| DSI_D1N | DSI_D1N is used as MIPI-DSI data Lane 0 negative. |
| DSI_CKP | DSI_CKP is used as clock Lane positive. |
| DSI_DKN | DSI_DKN is used as clock Lane negative. |
| PF2 | PF2 is used LCD interrupt lane. |
| PA15 | PA15 is used as DSI backlight control. ⁽¹⁾ |
| PD12 | PD12 used as I2C1_SCL for the touch panel, shared between USB, AUDIO, HDMI. |
| PF15 | PF15 used as I2C1_SDA for the touch panel, shared between USB, AUDIO, and HDMI. |

1. Not used. In the default configuration, backlight control is done by the LCD driver.

Figure 14 shows the the pinout of LCD connector CN4.

Figure 14. CN4 LCD connector pinout

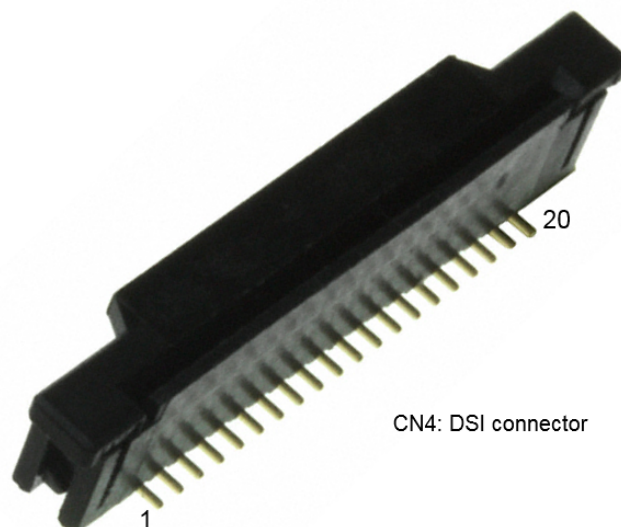


Table 20 describe the LCD interface and pinout of LCD connector CN4.

Table 20. LCD interface and CN4 connector pinout

| Pin | STM32 pin | Signal name | Function |
|-----|-----------|-------------|----------|
| 1 | - | GND | GND |
| 2 | DSI_D1N | DSI_D1_N | D1N |
| 3 | DSI_D1P | DSI_D1_P | D1P |
| 4 | - | GND | GND |
| 5 | DSI_CKN | DSI_CK_N | CKN |
| 6 | DSI_CKP | DSI_CK_P | CKP |
| 7 | - | GND | GND |
| 8 | DSI_D0N | DSI_D0_N | D0N |
| 9 | DSI_D0P | DSI_D0_P | D0P |
| 10 | - | GND | GND |
| 11 | PF0 | I2C1_SCL | SCL |
| 12 | PF14 | I2C1_SDA | SDA |
| 13 | - | GND | GND |
| 14 | - | 3V3 | 3V3 |
| 15 | - | 3V3 | 3V3 |
| 16 | - | GND | GND |
| 17 | PF2 | LCD_INT | INT |
| 18 | PC6 | DSI_TE | TE |
| 19 | PA15 | LCD_BL_CTRL | CTRL |
| 20 | PE4 | DSI_RESET | RESET |

7.15 Gigabit Ethernet

7.15.1 Description

The STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits provide a Gigabit reduced medium-independent interface (RGMII).

The STM32MP157x requires an external physical interface device (PHY). The Realtek RTL8211F-CG is the PHY on the Discovery kits. The PHY is connected to the physical LAN bus using 13 signals for RGMII. It can be clocked using the 25 MHz from the STM32MP157x or from a crystal (X2). The default configuration is 25 MHz from the X2 crystal.

LED LD3 is blinking to indicate the data transmission.

For more details about the PHY (such as clocking or configuration), refer to the datasheet of the Realtek RTL8211F-CG.

7.15.2 Operating voltage

The Ethernet PHY is supplied directly with 3.3 V. It generates its own 1.05 V supply and digital/analog 3.3 V.

7.15.3 Ethernet interface

Table 21 describes the I/O configuration of the Ethernet interface.

Table 21. I/O configuration of the Ethernet interface

| I/O | Configuration |
|------|---|
| PG0 | PG0 is used as ETH_NRST active Low. |
| PA2 | PA2 is used as ETH_MDIO. |
| PA6 | PA6 is used as ETH_MDINT. |
| PC1 | PB11 is used as ETH_MDC. |
| PA7 | PA7 is used as ETH_RX_DV. |
| PC4 | PB11 is used as ETH_RXD0. |
| PC5 | PB11 is used as ETH_RXD1. |
| PB0 | PB0 is used as ETH_RXD2. |
| PB1 | PB1 is used as ETH_RXD3. |
| PB11 | PB11 is used as ETH_TX_EN. |
| PG13 | PG13 is used as ETH_TXD0. |
| PG14 | PG14 is used as ETH_TXD1. |
| PC2 | PB11 is used as ETH_TXD2. |
| PE2 | PE2 is used as ETH_TXD3. |
| PA1 | PA1 is used as ETH_RX_CLK. |
| PG4 | PG4 is used as ETH_GTX_CLK. |
| PG5 | PG5 is used as ETH_CLK125. |
| PB5 | PB5 is used as ETH_CLK not the default configuration. |

Figure 15 shows the pinout of Ethernet connector CN8.

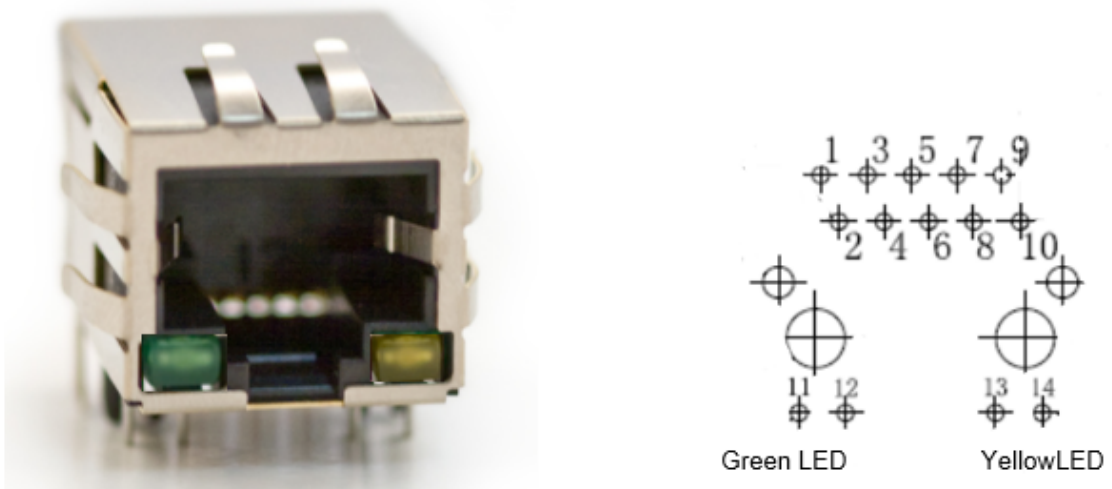
Figure 15. CN8 Ethernet connector pinout


Table 22. CN8 Ethernet connector pinout

| Pin | Pin name | Function |
|-----|----------|---|
| 1 | TX1+ | First bidirectional pair to transmit and receive data. |
| 2 | TX1- | |
| 3 | TX2+ | Second bidirectional pair to transmit and receive data. |
| 4 | TX2- | |
| 5 | CT1 | Common connected to GND. |
| 6 | CT2 | Common connected to GND. |
| 7 | TX3+ | Third bidirectional pair to transmit and receive data. |
| 8 | TX3- | |
| 9 | TX4+ | Fourth bidirectional pair to transmit and receive data. |
| 10 | TX4- | |
| 11 | GA | Green LED anode. |
| 12 | GC | Green LED cathode. |
| 13 | YA | Yellow LED anode. |
| 14 | YC | Yellow LED cathode. |
| 15 | GND | GND. |
| 16 | GND | GND. |

7.16 Arduino™ connectors

7.16.1 Description

The Arduino™ Uno V3 connectors (CN13, CN14, CN16, and CN17) are available on the STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits. Most shields designed for Arduino™ can fit with the Discovery kits to offer flexibility in small form factor applications.

7.16.2 Operating voltage

The Arduino™ Uno V3 connectors support 5 V, 3.3 V, and VDD for I/O compatibility.

Caution: Do not supply 3.3 V or 5 V from the Arduino™ shield. Supplying 3.3 V or 5 V from the Arduino™ shield could damage the Discovery kit.

7.16.3 Arduino™ interface

Figure 16 shows the pinout of the Arduino™ connectors.

Figure 16. Arduino™ connectors pinout

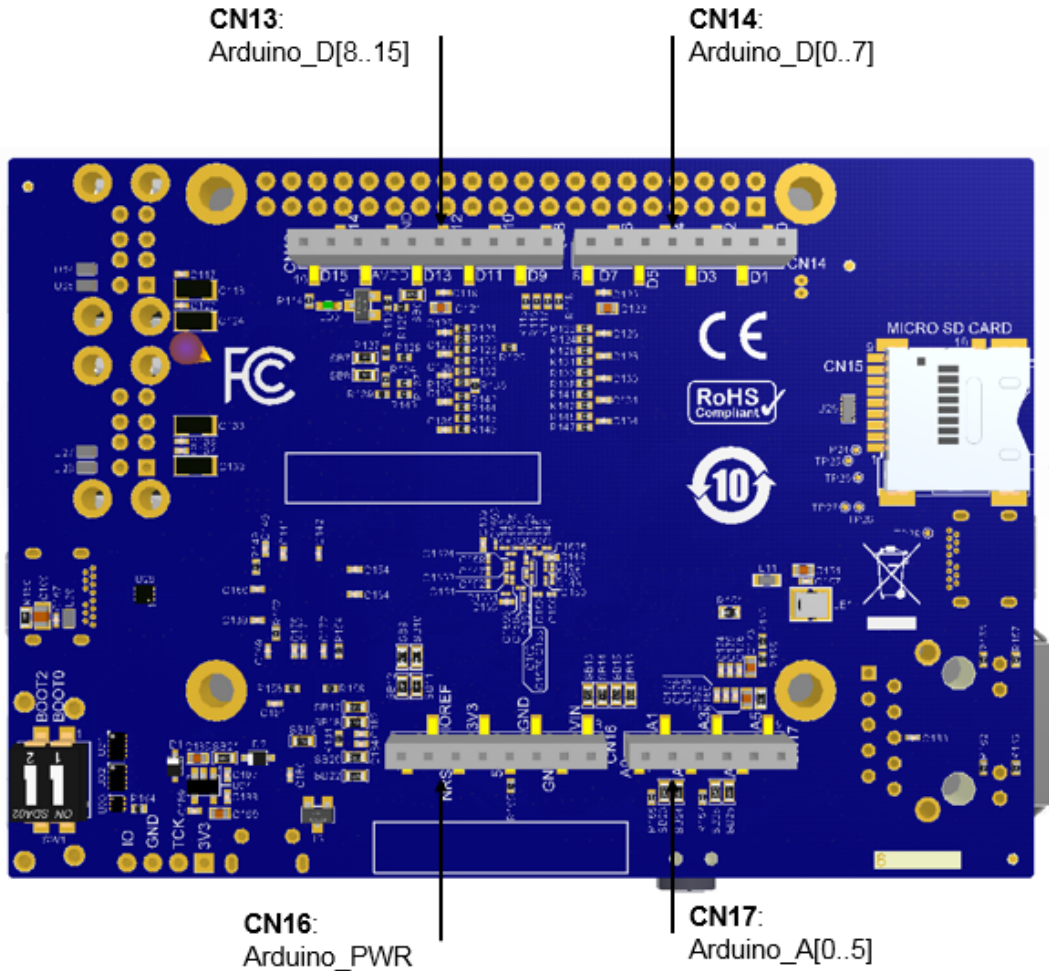


Table 23 describes the I/O configuration of the Arduino™ interface.

Table 23. I/O configuration of the Arduino™ interface

| I/O | HW | Configuration |
|------|---------|---|
| PF14 | - | PF14 is used as ARD_A0: ADC1_IN0 |
| PF13 | - | PF13 is used as ARD_A1: ADC1_IN1 |
| ANA0 | - | ANA0 is used as ARD_A2: ADC1_IN6 |
| ANA1 | - | ANA1 is used as ARD_A3: ADC1_IN2 |
| PC3 | SB24 ON | PC3 is used as ARD_A4: ADC1_IN13 Default configuration |
| PF12 | SB26 ON | PF12 is used as ARD_A5: ADC1_IN14 Default configuration |
| PE7 | - | PE7 is used as ARD_D0: USART7_RX |
| PE8 | - | PE8 is used as ARD_D1: USART7_TX |
| PE1 | - | PE1 is used as ARD_D2: IO |
| PD14 | - | PD14 is used as ARD_D3: TIM4_CH3 |
| PE10 | - | PE10 is used as ARD_D4: IO |

| I/O | HW | Configuration |
|------|----|--|
| PD15 | - | PD15 is used as ARD_D5: TIM4_CH4 |
| PE9 | - | PE9 is used as ARD_D6: TIM4_CH1 |
| PD1 | - | PD1 is used as ARD_D7: IO |
| PG3 | - | PG3 is used as ARD_D8: IO |
| PH6 | - | PH6 is used as ARD_D9: TIM12_CH1 |
| PE11 | - | PE11 is used as ARD_D10: SPI4_NSS, TIM1_CH2 |
| PE14 | - | PE14 is used as ARD_D11: SPI4_MOSI ,TIM1_CH4 |
| PE13 | - | PE13 is used as ARD_D12: SPI4_MISO |
| PE12 | - | PE12 is used as ARD_D13: SPI4_SCK |
| PA12 | - | PA12 used as ARD_D14: I2C5_SDA shared with ARD_A4 (SB23 ON / SB24 OFF) |
| PA11 | - | PA11 used as ARD_D15: I2C5_SCL shared with ARD_A5 (SB25 ON / SB26 OFF) |

Table 24 describes the pinout of the Arduino™ connectors.

Table 24. Pinout of the Arduino™ connectors

| Connector | Pin name | Signal name | STM32 pin | Comment |
|-----------|----------|-------------|-----------|------------------------|
| CN16 | 1 | NC | - | NC (reserved for test) |
| | 2 | 3V3 | - | IOREF 3V3 |
| | 3 | NRST | NRST | NRST |
| | 4 | 3V3 | - | 3V3 |
| | 5 | 5V | - | 5V |
| | 6 | GND | - | GND |
| | 7 | GND | - | GND |
| | 8 | VIN | | Not connected |
| CN17 | 1 | A0 | PF14 | ADC1_IN0 |
| | 2 | A1 | PF13 | ADC1_IN1 |
| | 3 | A2 | ANA0 | ADC1_IN6 |
| | 4 | A3 | ANA1 | ADC1_IN2 |
| | 5 | A4 | PC3/PA12 | ADC1_IN13 |
| | 6 | A5 | PF12/PA11 | |
| CN14 | 1 | ARD_D0 | PE7 | USART7_RX |
| | 2 | ARD_D1 | PE8 | USART7_TX |
| | 3 | ARD_D2 | PE1 | IO |
| | 4 | ARD_D3 | PD14 | TIM4_CH3 |
| | 5 | ARD_D4 | PE10 | IO |
| | 6 | ARD_D5 | PD15 | TIM4_CH4 |
| | 7 | ARD_D6 | PE9 | TIM1_CH1 |
| | 8 | ARD_D7 | PD1 | IO |

| Connector | Pin name | Signal name | STM32 pin | Comment |
|-----------|----------|-------------|-----------|------------------------|
| CN13 | 1 | ARD_D8 | PG3 | IO |
| | 2 | ARD_D9 | PH6 | TIM12_CH1 |
| | 3 | ARD_D10 | PE11 | SPI4_NSS and TIM1_CH2 |
| | 4 | ARD_D11 | PE14 | SPI4_MOSI and TIM1_CH4 |
| | 5 | ARD_D12 | PE13 | SPI4_MISO |
| | 6 | ARD_D13 | PE12 | SPI4_SCK |
| | 7 | GND | - | GND |
| | 8 | VREFP | - | VREF+ |
| | 9 | ARD_D14 | PA12 | I2C5_SDA |
| | 10 | ARD_D15 | PA11 | I2C5_SCL |

7.17 GPIO expansion connectors

7.17.1 Description

- The GPIO pins can be used as GPIOs or alternate functions. The available alternate functions are listed in [Table 25. GPIO connectors pinout](#).
- Other functions such as I²C, UART, or FDCAN can be mapped on the GPIO connectors, for instance using the [STM32CubeMX](#) tool.
- The GPIO expansion connector CN2 offers Raspberry Pi[®] shields capability.

7.17.2 GPIO expansion connector interface

[Figure 17](#) shows the pinout of the GPIO connectors.

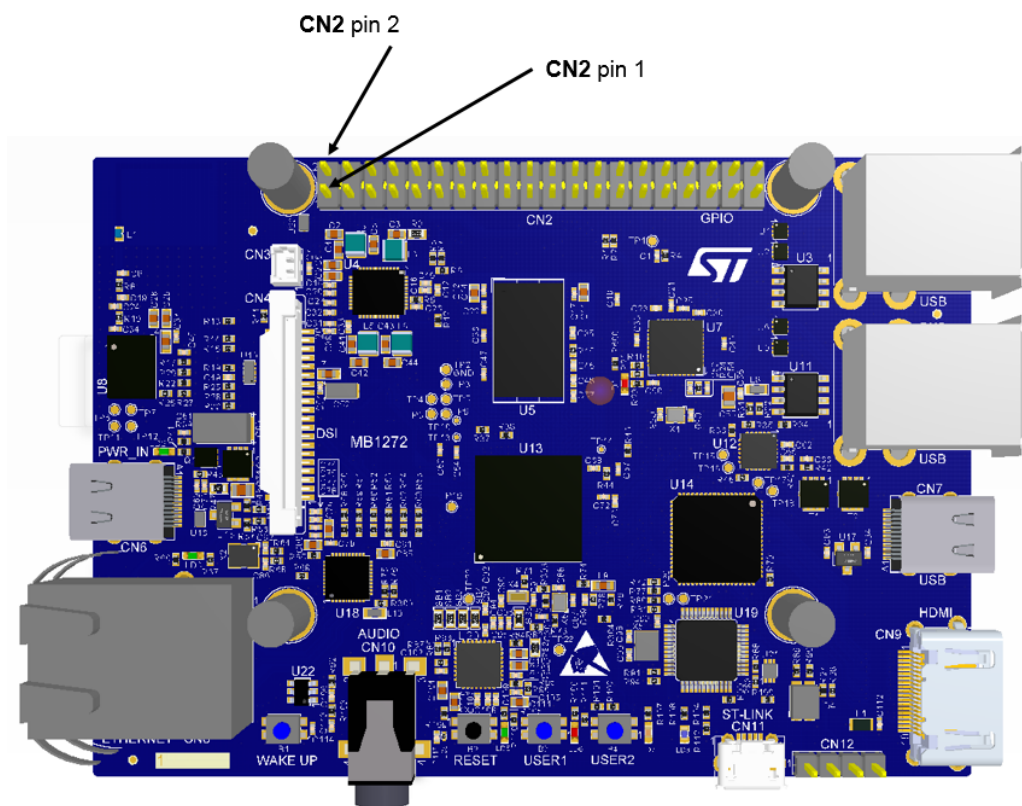
Figure 17. GPIO connectors


Table 25 describes the pinout of the GPIO connectors.

Table 25. GPIO connectors pinout

| Function | STM32 pin | Pin | Pin | STM32 pin | Function |
|---------------------|-----------|-----|-----|-----------|---------------------|
| 3V3 | - | 1 | 2 | - | 5V |
| GPIO2 / I2C5_SDA | PA12 | 3 | 4 | - | 5V |
| GPIO3 / I2C5_SCL | PA11 | 5 | 6 | - | GND |
| GPIO4 / MCO1 | PA8 | 7 | 8 | PB10 | GPIO14 / USART3_TX |
| GND | - | 9 | 10 | PB12 | GPIO15 / USART3_RX |
| GPIO17 / USART3_RTS | PG8 | 11 | 12 | PI5 | GPIO18 / SAI2_SCKA |
| GPIO27 / SDMMC3_D3 | PD7 | 13 | 14 | - | GND |
| GPIO22 / SDMMC3_CK | PG15 | 15 | 16 | PF1 | GPIO23 / SDMMC3_CMD |
| 3V3 | - | 17 | 18 | PF0 | GPIO24 / SDMMC3_D0 |
| GPIO10 / SPI5_MOSI | PF9 | 19 | 20 | - | GND |
| GPIO9 / SPI5_MISO | PF8 | 21 | 22 | PF4 | GPIO25 / SDMMC3_D1 |
| GPIO11 / SPI5_SCK | PF7 | 23 | 24 | PF6 | GPIO8 / SPI5_NSS |
| GND | - | 25 | 26 | PF3 | GPIO7 |
| I2C1_SDA | PF15 | 27 | 28 | PD12 | I2C1_SCL |
| GPIO5 / MCO2 | PG2 | 29 | 30 | - | GND |

| Function | STM32 pin | Pin | Pin | STM32 pin | Function |
|--------------------|-----------|-----|-----|-----------|---------------------|
| GPIO6 / TIM5_CH2 | PH11 | 31 | 32 | PD13 | GPIO12 / TIM4_CH2 |
| GPIO13 / TIM3_CH2 | PC7 | 33 | 34 | - | GND |
| GPIO19 / SAI2_FSA | PI7 | 35 | 36 | PB13 | GPIO16 / USART3_CTS |
| GPIO26 / SDMMC3_D2 | PF5 | 37 | 38 | PI6 | GPIO20 / SAI2_SDA |
| GND | - | 39 | 40 | PF11 | GPIO21 / SAI2_SDB |

8 STM32MP157A-DK1 and STM32MP157C-DK2 I/O assignment

Table 26. Discovery kit I/O assignment

| Ball | Pin | Assignment |
|------|------|----------------------------|
| A2 | PH5 | BT_HOST_WAKE |
| C2 | PH10 | LTDC_R4 |
| B2 | PH12 | LTDC_R6 |
| D1 | PH13 | LTDC_G2 |
| C3 | PH14 | LTDC_G3 |
| B1 | PH15 | LTDC_G4 |
| C1 | PI0 | LTDC_G5 |
| E3 | PI1 | LTDC_G6 |
| E2 | PI2 | LTDC_G7 |
| E1 | PI3 | HDMI_I2S2_MOSI |
| E4 | PI4 | LTDC_B4 |
| F3 | PI5 | SAI2_SCKA |
| F4 | PI6 | SAI2_SDA |
| F2 | PI7 | SAI2_FSA |
| G1 | PZ1 | BT_PCM_1_SDI |
| G4 | PZ3 | BT_PCM_1_WS |
| H4 | PI9 | LTDC_VSYNC |
| G3 | PZ0 | BT_PCM_1_CK |
| J4 | PZ2 | BT_PCM_1_SDO |
| G2 | PZ4 | PMIC_I2C4_SCL |
| K4 | PG12 | LTDC_B1 |
| H2 | PZ5 | PMIC_I2C4_SDA |
| H1 | PZ6 | BT_REG_ON |
| J3 | PZ7 | BT_DEV_WAKE |
| D2 | PD6 | BT_USART2_RX |
| L3 | PD14 | ARDUINO_D3_TIM4_CH3 |
| J2 | PD15 | ARDUINO_D5_TIM4_CH4 |
| K3 | PD8 | LTDC_B7 |
| K1 | PD9 | LTDC_B0 |
| L4 | PI8 | LPO_32OUT2 |
| K2 | PC13 | PC13_ANTI_TAMP_PMIC_WAKEUP |
| N2 | PA13 | LED1_GPIO |
| T2 | PA14 | LED2_GPIO |
| P4 | PI11 | PI11_STUSB1600_IRQN_WKUP5 |
| T1 | PI10 | LTDC_HSYNC |
| W4 | PH7 | LED_Y_GPIO |
| U1 | PF3 | GPIO7_GPIO |

| Ball | Pin | Assignment |
|------|------|---------------------------|
| W2 | PC3 | ARDUINO_A4_ADC1_IN13 |
| T4 | PG3 | ARDUINO_D8_GPIO |
| Y1 | PE2 | ETH_TXD3 |
| U2 | PA3 | LTDC_B5 |
| Y2 | PC2 | ETH_TXD2 |
| V2 | PG2 | GPIO5_MCO2 |
| AA1 | PG14 | ETH_TXD1 |
| W1 | PG1 | HDMI_INT_GPIO |
| AA2 | PG13 | ETH_TXD0 |
| U3 | ANA0 | ARDUINO_A0_ADC1_IN0 |
| AB3 | PA0 | PA0_WKUP_PMIC_INT |
| U4 | ANA1 | ARDUINO_A1_ADC1_IN1 |
| AA4 | PA1 | ETH_REF_CLK |
| V3 | PA5 | TypeC_Power_CC2_ADC1_IN19 |
| V4 | PA4 | TypeC_Power_CC1_ADC1_IN18 |
| AB1 | PB11 | ETH_TX_EN |
| AB2 | PG4 | ETH_GTX_CLK |
| AC3 | PA2 | ETH_MDIO |
| AA6 | PC1 | ETH_MDC |
| Y6 | PG5 | ETH_CLK125 |
| AA3 | PH3 | LTDC_R1 |
| AB6 | PB0 | ETH_RXD2 |
| Y4 | PF15 | IDSD_BOARD_I2C1_SDA |
| AA7 | PB1 | ETH_RXD3 |
| AC4 | PF14 | ARDUINO_A2_ADC2_IN6 |
| Y5 | PF13 | ARDUINO_A3_ADC2_IN2 |
| AB4 | PH2 | LTDC_R0 |
| AB7 | PC5 | ETH_RXD1 |
| AC7 | PC4 | ETH_RXD0 |
| Y9 | PF12 | ARDUINO_A5_ADC1_IN6 |
| Y10 | PF11 | SAI2_SD_B |
| AB8 | PA7 | ETH_RXDV |
| AC8 | PA6 | ETH_MDINT |
| AB5 | PC0 | LTDC_R5 |
| Y3 | PB10 | GPIO14_USART3_TX |
| AC5 | PB12 | GPIO15_USART3_RX |
| AA10 | PB13 | GPIO16_USART3_CTS_NSS |
| Y8 | PB5 | ETH_ETH_CLK |
| Y7 | PG11 | STLK_UART4_TX |
| Y11 | PH6 | ARDUINO_D9_TIM12_CH1 |

| Ball | Pin | Assignment |
|------|------|----------------------------|
| AB10 | PB8 | LTDC_B6 |
| AB9 | PG8 | GPIO17_USART3_RTS |
| AB11 | PG10 | LTDC_B2 |
| AA9 | PE9 | ARDUINO_D6_TIM1_CH1 |
| AA11 | PE7 | ARDUINO_D0_UART7_RX |
| AC10 | PD11 | LED_B_GPIO |
| AB12 | PF7 | GPIO11_SPI5_SCK |
| AC11 | PF8 | GPIO9_SPI5_MISO |
| Y12 | PF10 | LTDC_DE |
| AA13 | PF6 | GPIO8_SPI5_NSS |
| Y18 | PD12 | I2C1_SCL |
| AA14 | PF9 | GPIO10_SPI5_MOSI |
| AC14 | PG7 | LTDC_CLK |
| Y14 | PB6 | HDMI_CEC |
| AC13 | PE8 | ARDUINO_D1_UART7_TX |
| Y15 | PE10 | ARDUINO_D4_GPIO |
| Y16 | PB2 | STLK_UART4_RX |
| AA19 | PD13 | GPIO12_TIM4_CH2 |
| Y13 | PG9 | AUDIO_RST |
| AB19 | PA12 | ARDUINO_D14_GPIO3_I2C5_SDA |
| AA18 | PA11 | ARDUINO_D15_GPIO2_I2C5_SCL |
| D16 | PC11 | uSD_SDMMC1_D3 |
| D19 | PE4 | DSI_RESET_GPIO |
| D18 | PC8 | uSD_SDMMC1_D0 |
| D15 | PC10 | uSD_SDMMC1_D2 |
| B13 | PB4 | WLAN_SDMMC2_D3 |
| D17 | PC9 | uSD_SDMMC1_D1 |
| B11 | PC7 | GPIO13_TIM3_CH2 |
| B14 | PC6 | DSI_TE |
| A14 | PF2 | DSI_LCD_INT_GPIO |
| D12 | PD2 | uSD_SDMMC1_CMD |
| A13 | PA8 | GPIO4_MCO1 |
| C13 | PB14 | WLAN_SDMMC2_D0 |
| D13 | PC12 | uSD_SDMMC1_CK |
| B12 | PB15 | WLAN_SDMMC2_D1 |
| C11 | PE5 | LTDC_G0 |
| A11 | PB3 | WLAN_SDMMC2_D2 |
| A10 | PG6 | WLAN_SDMMC2_CMD |
| D14 | PD3 | BT_USART2_CTS_NSS |
| B10 | PB9 | HDMI_I2S2_NSS/2_WS |

| Ball | Pin | Assignment |
|------|------|--------------------------------|
| C19 | PA15 | DSI_LCD_BLCTRL_TIM2_CH1/2_ETR |
| A8 | PA9 | HDMI_I2S2_SCK/2_CK |
| D11 | PB7 | uSD_detect_GPIO |
| B9 | PD1 | ARDUINO_D7_GPIO |
| B8 | PD0 | WLAN_HOST_WAKE_GPIO |
| C9 | PE3 | WLAN_SDMMC2_CK |
| A7 | PD5 | BT_USART2_TX |
| D10 | PD7 | GPIO27_SDMMC3_D3 |
| B7 | PG15 | GPIO22_SDMMC3_CK |
| C10 | PE6 | LTDC_G1 |
| D8 | PF0 | GPIO24_SDMMC3_D0 |
| A5 | PF1 | GPIO23_SDMMC3_CMD |
| D9 | PF4 | GPIO25_SDMMC3_D1 |
| B6 | PD4 | BT_USART2_RTS |
| D7 | PF5 | GPIO26_SDMMC3_D2 |
| B5 | PD10 | LTDC_B3 |
| D6 | PE0 | SAI2_MCLK_A |
| C8 | PE1 | ARDUINO_D2_GPIO |
| D5 | PH8 | LTDC_R2 |
| C5 | PH9 | LTDC_R3 |
| A4 | PE11 | ARDUINO_D10_SPI4_NSS/TIM1_CH2 |
| B4 | PE12 | ARDUINO_D13_SPI4_SCK |
| A3 | PE13 | ARDUINO_D12_SPI4_MISO |
| C4 | PH11 | GPIO6_TIM5_CH2 |
| C6 | PE14 | ARDUINO_D11_SPI4_MOSI/TIM1_CH4 |
| D3 | PE15 | LTDC_R7 |
| B3 | PH4 | WLAN_REG_ON_GPIO |

9 Federal Communications Commission (FCC) and Industry Canada (IC) Compliance Statements

Identification of products: STM32MP157A-DK1 and STM32MP157C-DK2

Part 15.19

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Part 15.21

Any changes or modifications to this equipment not expressly approved by STMicroelectronics may cause harmful interference and void the user's authority to operate this equipment.

Part 15.105

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

Note: Use only shielded cables for USB, Ethernet, HDMI® cables. Use added ferrite clamp on audio cable (one turn).

Responsible party (in the USA)

Terry Blanchard
Americas Region Legal | Group Vice President and Regional Legal Counsel, The Americas
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Industry Canada ICES-003

CAN ICES-3 (A) / NMB-3 (A)

9.1 Additional FCC and IC Compliance Statements for STM32MP157C-DK2

Contains FCC ID: VPYLB1DX

Contains IC:772C-LB1DX

ISED Licence-Exempt Radio Apparatus

This device contains license-exempt transmitter(s)/receiver(s) that comply with Innovation, Science and Economic Development Canada's license-exempt RSS(s). Operation is subject to the following two conditions:

1. This device may not cause interference.
2. This device must accept any interference, including interference that may cause undesired operation of the device.

Appareils radio exempts de licence ISDE

L'émetteur/récepteur exempt de licence contenu dans le présent appareil est conforme aux CNR d'Innovation, Sciences et Développement économique Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes :

1. L'appareil ne doit pas produire de brouillage ;

2. L'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Radio Frequency (RF) Exposure Compliance of Radiocommunication Apparatus

To satisfy FCC and IC RF Exposure requirements for mobile devices, a separation distance of 20 cm or more should be maintained between the antenna of this device and persons during operation. To ensure compliance, operation at closer than this distance is not recommended. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

Pour satisfaire aux exigences FCC et IC concernant l'exposition aux champs RF pour les appareils mobile, une distance de séparation de 20 cm ou plus doit être maintenu entre l'antenne de ce dispositif et les personnes pendant le fonctionnement. Pour assurer la conformité, il est déconseillé d'utiliser cet équipement à une distance inférieure. Cet émetteur ne doit pas être co-situé ou fonctionner conjointement avec une autre antenne ou un autre émetteur.

10 CE conformity

10.1 Warning

EN 55032 / CISPR32 (2012) Class A product

Warning: this device is compliant with Class A of EN55032 / CISPR32. In a residential environment, this equipment may cause radio interference.

10.2 Simplified declaration of conformity

Hereby, STMicroelectronics declares that the radio equipment types STM32MP157A-DK1 and STM32MP157C-DK2 are in compliance with Directive 2014/53/EU. The full text of the EU declaration of conformity is available on the next page.

UE Declaration of Conformity

Document Number:

We, the undersigned,

Manufacturer or representative: STMicroelectronics
 Address: Avenue Celestin Coq, PO Box 13106, ROUSSET13106 FRANCE
 Country: FRANCE
 Phone number: (Ext: +33) 4 42 68 89 93
 E-mail: joel.huloux@st.com

Designated product,

Description: Discovery kits with STM32MP157 MPUs
 Brand name or trade mark: STMicroelectronics
 Identification / Designation: STM32MP157C-DK2, STM32MP157A-DK1
 Restrictive use: Indoor use only.
 Frequency band 1: 2400-2483.5MHz (Bluetooth, WIFI)
 Max power: 100mW e.i.r.p

Certify and declare under our sole responsibility that the designated product is in conformity with the essential requirements and provisions of the following European Directives:

Directive **2014/53/EU** of the European Parliament and of the Council of 16 April 2014 on the harmonisation of the laws of the Member States relating to the making available on the market of **radio equipment (RED)**.
The conformity of the designated product(s) with the provisions of this European Directive is given by the compliance with the following European Standard(s):

| | |
|---|--|
| Essential requirements of article 3.1a) of RED: (Safety, electrical) | - EN 60950-1 (2006+A11/2009+A1/2010+A12/2011+A2/2013) |
| Essential requirements of article 3.1a) of RED: (Safety, health) | - EN 62311 (2008) |
| Essential requirements of article 3.1b) of RED: (Electromagnetic Compatibility) | - EN 55032 (2012) / EN 55024 (2010) - ETSI EN 301 489-1 (V2.1.1 + Draft V2.2.0) - ETSI EN 301 489-17 (V3.1.1 + Draft V3.2.0) |
| Essential requirements of article 3.2) of RED: (Efficient use of radio spectrum) | - ETSI EN 300 328 (V2.1.1) |

Directive **2011/65/EU** of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances (**ROHS**) in electrical and electronic equipment.

Directive **2012/19/EU** of the European Parliament and of the Council of 4 July 2012 on waste electrical and electronic equipment (**WEEE**).

Name and position of person binding the manufacturer or his authorised representative

Name: HULOUX Joel
 Position: Director Lobbying & Standardization
 Address: Avenue Celestin Coq, PO Box 13106, ROUSSET13106 FRANCE
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 Signature:

20 April 2019

Revision history

Table 27. Document revision history

| Date | Version | Changes |
|-------------|---------|------------------|
| 25-Mar-2019 | 1 | Initial release. |

Contents

| | | |
|----------|--|----------|
| 1 | Features | 2 |
| 2 | Ordering information | 3 |
| 2.1 | Product marking | 3 |
| 2.2 | Codification | 3 |
| 3 | Development environment | 4 |
| 3.1 | Demonstration software | 4 |
| 3.2 | Development toolchains | 4 |
| 3.3 | System requirements | 4 |
| 4 | Technology partners | 5 |
| 5 | Conventions | 6 |
| 6 | Delivery recommendations | 7 |
| 7 | Hardware layout and configuration | 8 |
| 7.1 | Embedded ST-LINK/V2-1 | 10 |
| 7.1.1 | Description | 10 |
| 7.1.2 | Drivers | 11 |
| 7.1.3 | ST-LINK/V2-1 firmware upgrade | 11 |
| 7.2 | Power supply | 11 |
| 7.2.1 | 5 V power supply | 11 |
| 7.2.2 | STPMIC1 power supply | 11 |
| 7.3 | Clock sources | 12 |
| 7.3.1 | LSE clock references | 12 |
| 7.3.2 | HSE clock references | 12 |
| 7.4 | Reset sources | 12 |
| 7.5 | Boot mode | 12 |
| 7.5.1 | Description | 12 |
| 7.6 | Audio | 13 |
| 7.6.1 | Description | 13 |
| 7.6.2 | Operating voltage | 13 |
| 7.6.3 | Audio codec interface | 13 |

| | | |
|-------------|---|-----------|
| 7.6.4 | Headphone outputs | 13 |
| 7.6.5 | Audio jack connector | 14 |
| 7.6.6 | I/O restriction | 14 |
| 7.7 | USB Host | 14 |
| 7.7.1 | Description | 14 |
| 7.7.2 | USB Host interface | 14 |
| 7.8 | USB Type-C™ HS | 16 |
| 7.8.1 | Description | 16 |
| 7.8.2 | Operating voltage | 16 |
| 7.8.3 | USB HS Source | 16 |
| 7.8.4 | USB Type-C™ connector | 16 |
| 7.9 | microSD™ card | 17 |
| 7.9.1 | Description | 17 |
| 7.9.2 | Operating voltage | 17 |
| 7.9.3 | microSD™ card interface | 17 |
| 7.10 | LEDs | 18 |
| 7.10.1 | Description | 18 |
| 7.10.2 | Operating voltage | 19 |
| 7.10.3 | LED interface | 19 |
| 7.11 | Buttons | 19 |
| 7.11.1 | Description | 19 |
| 7.11.2 | I/O interface | 19 |
| 7.12 | HDMI® | 19 |
| 7.12.1 | Description | 19 |
| 7.12.2 | HDMI® I/O interface | 20 |
| 7.13 | Wi-Fi® and Bluetooth® Low Energy | 22 |
| 7.13.1 | Description | 22 |
| 7.13.2 | Operating voltage | 22 |
| 7.13.3 | Wi-Fi® I/O interface | 22 |
| 7.13.4 | Bluetooth® Low Energy I/O interface | 22 |
| 7.14 | MIPI DSISM LCD | 23 |

| | | |
|-------------|---|-----------|
| 7.14.1 | Description | 23 |
| 7.14.2 | Operating voltage | 23 |
| 7.14.3 | LCD interface | 24 |
| 7.15 | Gigabit Ethernet | 25 |
| 7.15.1 | Description | 25 |
| 7.15.2 | Operating voltage | 25 |
| 7.15.3 | Ethernet interface | 25 |
| 7.16 | Arduino™ connectors | 27 |
| 7.16.1 | Description | 27 |
| 7.16.2 | Operating voltage | 27 |
| 7.16.3 | Arduino™ interface | 27 |
| 7.17 | GPIO expansion connectors | 30 |
| 7.17.1 | Description | 30 |
| 7.17.2 | GPIO expansion connector interface | 30 |
| 8 | STM32MP157A-DK1 and STM32MP157C-DK2 I/O assignment..... | 33 |
| 9 | Federal Communications Commission (FCC) and Industry Canada (IC) Compliance Statements | 37 |
| 9.1 | Additional FCC and IC Compliance Statements for STM32MP157C-DK2 | 37 |
| 10 | CE conformity | 39 |
| 10.1 | Warning | 39 |
| 10.2 | Simplified declaration of conformity | 39 |
| | Revision history | 41 |
| | Contents | 42 |
| | List of tables | 45 |
| | List of figures..... | 46 |

List of tables

| | | |
|------------------|---|----|
| Table 1. | List of available products | 3 |
| Table 2. | Codification explanation | 3 |
| Table 3. | ON/OFF convention | 6 |
| Table 4. | CN11 ST-LINK USB Micro-B connector pinout | 11 |
| Table 5. | Boot mode pins | 12 |
| Table 6. | I/O configuration for the audio interface | 13 |
| Table 7. | CN10 audio jack connector pinout | 14 |
| Table 8. | I/O configuration for the USB Host interface | 15 |
| Table 9. | CN1 and CN5 USB Host connector pinout | 15 |
| Table 10. | CN7 USB Type-C™ connector pinout | 16 |
| Table 11. | I/O configuration for the SDIO interface | 17 |
| Table 12. | CN15 microSD™ connector pinout | 18 |
| Table 13. | I/O configuration of the LED interfaces | 19 |
| Table 14. | I/O configuration for the physical user interface | 19 |
| Table 15. | I/O configuration for the HDMI® interface | 20 |
| Table 16. | CN9 HDMI® connector pinout | 21 |
| Table 17. | I/O configuration for the Wi-Fi® interface | 22 |
| Table 18. | I/O configuration for the Bluetooth® Low Energy interface | 22 |
| Table 19. | I/O configuration of the LCD and CTP interfaces | 24 |
| Table 20. | LCD interface and CN4 connector pinout | 25 |
| Table 21. | I/O configuration of the Ethernet interface | 26 |
| Table 22. | CN8 Ethernet connector pinout | 27 |
| Table 23. | I/O configuration of the Arduino™ interface | 28 |
| Table 24. | Pinout of the Arduino™ connectors | 29 |
| Table 25. | GPIO connectors pinout | 31 |
| Table 26. | Discovery kit I/O assignment | 33 |
| Table 27. | Document revision history | 41 |

List of figures

| | | |
|-------------------|---|----|
| Figure 1. | STM32MP157C-DK2 top view | 1 |
| Figure 2. | STM32MP157C-DK2 bottom view | 1 |
| Figure 3. | STM32MP157x-DKx hardware block diagram | 8 |
| Figure 4. | STM32MP157X-DKX PCB layout: TOP side | 9 |
| Figure 5. | STM32MP157X-DKX PCB layout: BOTTOM side | 10 |
| Figure 6. | CN11 ST-LINK USB Micro-B connector pinout | 10 |
| Figure 7. | Boot-mode switch SW1 | 13 |
| Figure 8. | CN10 audio jack connector pinout | 14 |
| Figure 9. | CN1 and CN5 USB Type-A connector pinout | 15 |
| Figure 10. | CN7 USB Type-C™ connector pinout | 16 |
| Figure 11. | microSD™ card connector CN15 | 18 |
| Figure 12. | CN9 HDMI® connector pinout | 21 |
| Figure 13. | LCD connection to MB1407 | 23 |
| Figure 14. | CN4 LCD connector pinout | 24 |
| Figure 15. | CN8 Ethernet connector pinout | 26 |
| Figure 16. | Arduino™ connectors pinout | 28 |
| Figure 17. | GPIO connectors | 31 |

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